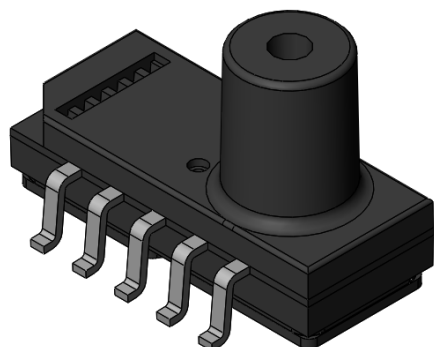


Low Pressure Digital Sensor

SM4233-HGL-S-005-000 Gauge Pressure Sensor



FEATURES

- Pressure range of -5 to 0 PSI gauge output
- Accuracy: $\pm 3\%$ full scale
- 16-bit digital, pressure calibrated and temperature compensated output
- I²C Digital
- Compensated temperature range: 0 to +85 °C
- Insensitive to mounting orientation
- Robust JEDEC SOIC-10 package for automated assembly
- Manufactured according to ISO9001 and ISO/TS 16949 standards

DESCRIPTION

The SM4233 is a digital, low pressure MEMS sensor, offering state-of-the-art pressure transducer technology and CMOS mixed signal processing technology to produce a digital, fully conditioned, pressure and temperature compensated sensor in JEDEC standard SOIC-10 package with vertical port. It is a gauge pressure sensor.

Combining the pressure sensor with a signal-conditioning ASIC in a single package simplifies the use of advanced silicon micro-machined pressure sensors. The pressure sensor can be mounted directly on a standard printed circuit board and a high level, calibrated pressure signal can be acquired from the output interface. This eliminates the need for additional circuitry, such as a compensation network or microcontroller containing a custom correction algorithm.

The SM4233 is available for shipment in sticks or tape & reel.

1. Absolute Maximum Ratings

No.	Characteristic	Symbol	Minimum	Maximum	Units
1	Supply Voltage	V_{DD}	-0.3	6.0	V
2	Digital IO Voltage	$V_{IO,DIG}$	-0.3	VDD+0.3	V
3	Max. Digital IO Current (DC)	$I_{IO,DIG}$	-10	+10	mA
4	Storage Temperature ^(a)	T_{STG}	-40	+125	°C

No.	Characteristic	Symbol	Minimum
5	Proof Pressure ^(a, b, c)	P_{Proof}	25 PSI
6	Burst Pressure ^(a, b, d)	P_{Burst}	40 PSI

Notes:

- Tested on a sample basis.
- Clean, dry gas compatible with wetted materials. Wetted materials include plastic, silicon and RTV.
- Proof pressure is defined as the maximum pressure to which the device can be taken and still perform within specifications after returning to the operating pressure range
- Burst pressure is the pressure at which the device suffers catastrophic failure resulting in pressure loss through the device.

2. ESD

No.	Description	Symbol	Minimum	Maximum	Units
1	ESD HBM Protection at all Pins	$V_{ESD(HBM)}$	-2	2	kV

3. External Components

No.	Description	Symbol	Min.	Typ.	Max.	Units
1	Supply bypass capacitor*	C_{VDD}		100		nF
2	I ² C Data and clock pull up resistors*	R_p		4.7		kΩ

* Not tested in production

4. Recommended Operating Conditions

The recommended operating conditions must not be exceeded in order to ensure proper functionality of the device. All parameters specified in the following sections refer to these recommended operating conditions unless stated otherwise.

No.	Description	Symbol	Min.	Typ.	Max.	Units
1	Supply Voltage	V_{VDD}	3.0	3.3	3.6	V
2	Low level input voltage at SDA, SCL	$V_{IN,I2C,lo}$	-0.3		0.9	V
3	High level input voltage at SDA, SCL	$V_{IN,I2C,hi}$	$0.8 * V_{VDD}$		$V_{VDD}+0.3$	V
4	Compensated Temperature	T_{COMP}	0		85	°C
5	Operating Temperature	T_A	0		85	°C

5. Operating Characteristics Table

All parameters are specified at Vdd = 3.3 V DC supply voltage at 25°C, unless otherwise noted.

No.	Characteristic	Symbol	Minimum	Typical	Maximum	Units
6	Current Consumption	I_{VDD}		3.3	4.0	mA
7	Pressure Output @ $P_{MIN} = -5$ PSI	OUT_{MIN}		-26,214		Counts
8	Pressure Output @ $P_{MAX} = 0$ PSI	OUT_{MAX}		+26,214		Counts
9	Full Scale Span	FSS		52,428		Counts
10	Resolution			16		Bits
11	Update Rate			2000		S/sec
12	Bandwidth			20		Hz
13	Digital Accuracy ^(e)	D ACC	-3		+3	%FS

Notes:

- e. The accuracy specification applies over all operating conditions. This specification includes the combination of linearity, repeatability, and hysteresis errors over pressure, temperature, and voltage.

6. I²C Interface

No.	Description	Condition	Symbol	Min.	Typ.	Max.	Units
1	SDA output low voltage*	I _{SDA} = 3 mA	V _{SDA,OL}	0		0.4	V
2	Low-to-High transition threshold*	pins SA0, SCL	V _{SDA,LH}	50	60	70	%VDD
3	High-to-Low transition threshold*	pins SA0, SCL	V _{SDA,HL}	30	40	50	%VDD
4	I ² C clock frequency*		f _{SCL}			400	kHz
5	Bus free time between a START and STOP condition*		t _{BUSF}	1300			ns
6	Clock low time*		t _{LO}	1300			ns
7	Clock high time*		t _{HI}	600			ns
8	START condition hold time*		t _{SH}	100			ns
9	Data setup time*		t _{SU}	100			ns
10	Data hold time*		t _H	0			ns
11	Setup time for repeated START condition*		t _{RSH}	600			ns
12	Setup time for STOP condition*		t _{PSU}	600			ns
13	Rise time of SDA and SCL signals*		t _R			300	ns
14	Fall time of SDA and SCL signals*		t _F			300	ns

* Not tested in production

Qualification Standards

REACH Compliant

RoHS Compliant

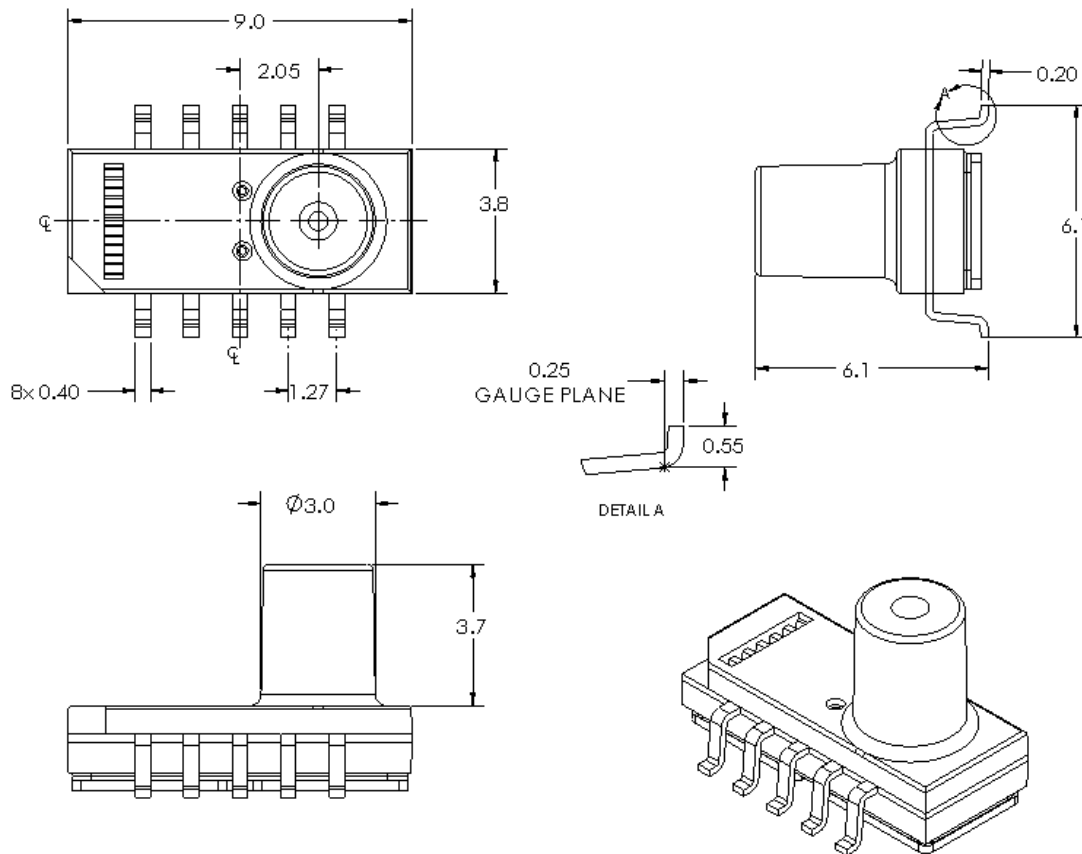
PFOS/PFOA Compliant

For qualification specifications, please contact Sales at sales@si-micro.com



7. Package Reference

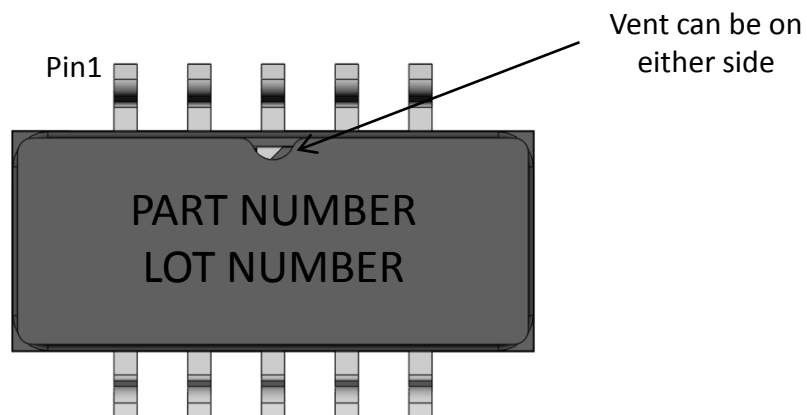
SM4233 Package Dimensions



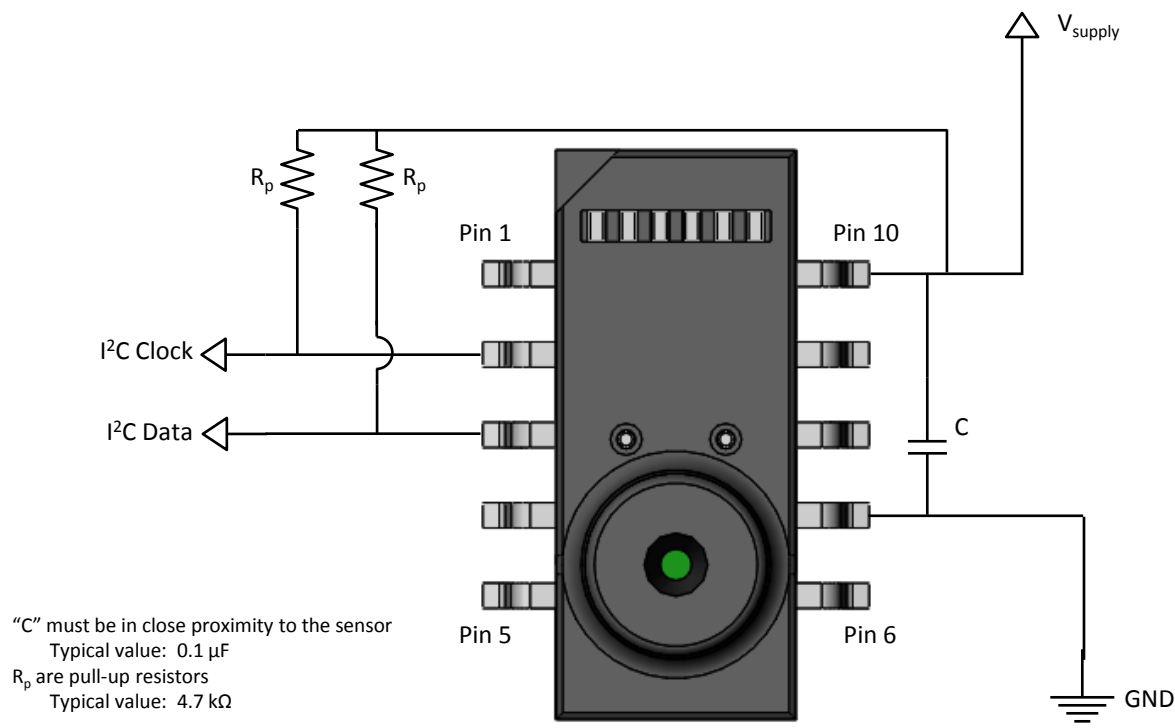
Notes:

- All dimensions in units of [mm]
- Moisture Sensitivity Level (MSL): Level 1
- Wetted materials: Silicon, RTV, Plastic

Part & Lot Number Identification



SM4233-Pin out Diagram

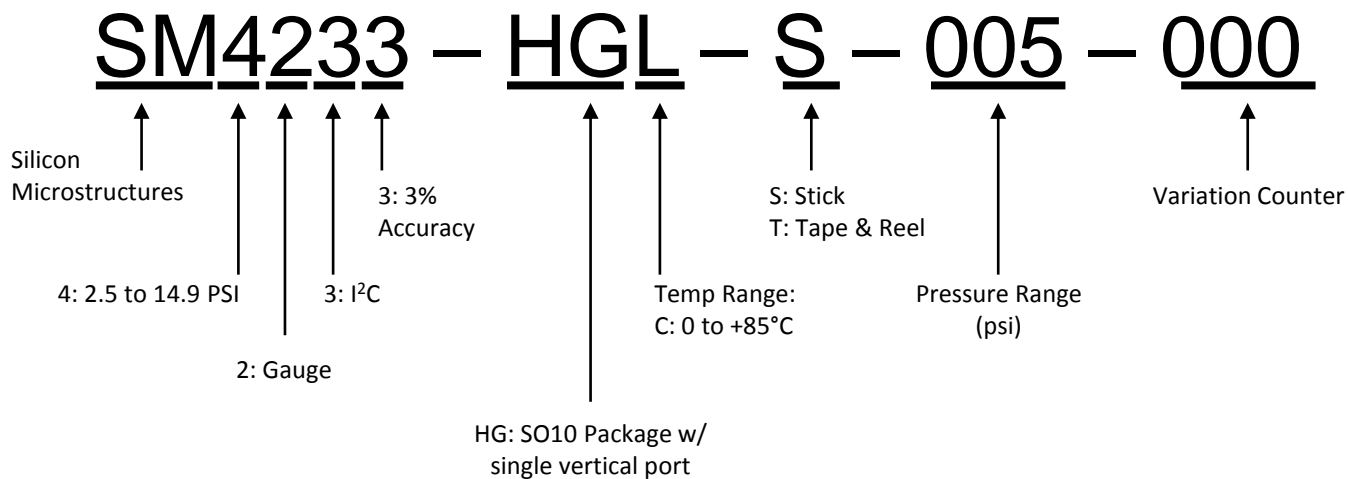


Pin No.	Pin Function
1	NC
2	SCL
3	SDA
4	NC
5	NC
6	NC
7	GND
8	NC
9	NC
10	Power

NOTES:

- Do not connect to NC pins

8. Part Number Legend



Qualification Standards

REACH Compliant

RoHS Compliant

PFOS/PFOA Compliant

For qualification specifications, please contact Sales at sales@si-micro.com



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